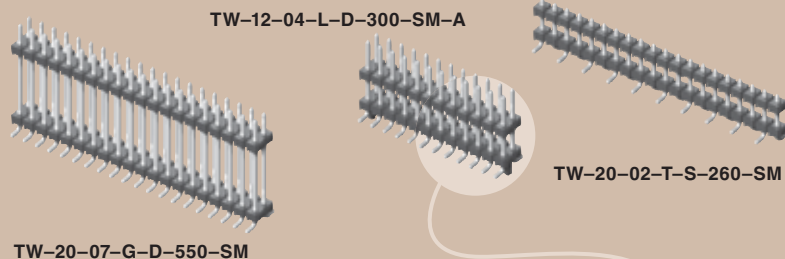




Surface
SMT
Mount

BOARD STACKER TW SERIES



SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?TW

Insulator Material:

Black Liquid
Crystal Polymer

Terminal Material:

Phosphor Bronze

Plating:

Sn or Au over 50µ"
(1,27µm) Ni

Current Rating:

3A @ 80°C ambient

Operating Temp Range:

-55°C to +105°C with Tin;

-55°C to +125°C with Gold

RoHS Compliant:

Yes

Processing:

Max Processing Temp:

230°C for 60 seconds, or

260°C for 20 seconds 3x

Lead-Free Solderable:

Yes

SMT Lead Coplanarity:

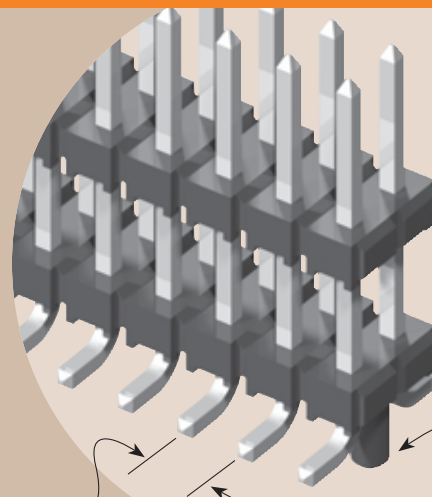
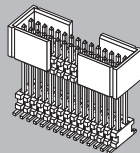
(0,15mm) .006" max



Mates with:
CLT, SQT, SQW, ESQT,
TLE SMM, MMS, TCSD

APPLICATION SPECIFIC OPTIONS

End shrouds with or without
guide posts available.
Call Samtec for stacker
height ranges and standard
part numbers on double row.



(2,00mm)
.0787" pitch

Available with
optional
Pick & Place
Pads

Available with
optional
Alignment Pins
or Locking Clips

TW	NO. PINS PER ROW	LEAD STYLE	PLATING OPTION	ROW OPTION	STACKER HEIGHT	SM	OTHER OPTIONS
	02 thru 36	Specify LEAD STYLE from chart below.	—L = 10µ" (0,25µm) Gold post, Matte Tin on tail —G = 20µ" (0,51µm) Gold post, Gold flash on tail —T = Matte Tin	—S = Single Row —D = Double Row	—“XXX” = Stacker Height In inches (0,13mm) .005" increments Example: -250 = (6,35mm) .250"		—“XXX” = Polarized Position —A = Alignment Pin (Metal or plastic at Samtec discretion) (4,83mm) .190" min. board space (-D only) —P = Pick & Place Pad (1,91mm) .075" min. post height (04-36 only) —TR = Tape & Reel Packaging (-07 lead style not available) (-06 lead style with -P option not available as a standard)